

January 2014

# FDB86360 F085

# N-Channel Power Trench® MOSFET

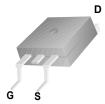
**80V**, **110A**, **1.8m** $\Omega$ 

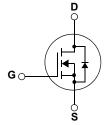
#### **Features**

- Typ  $r_{DS(on)}$  = 1.5m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80A
- Typ  $Q_{g(tot)}$  = 207nC at  $V_{GS}$  = 10V,  $I_D$  = 80A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

# **Applications**

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Integrated Starter/alternator
- Primary Switch for 12V Systems





**TO-263 FDB SERIES** 

For current package drawing, please refer to the Fairchild website at www.fairchildsemi.com/packaging



# MOSFET Maximum Ratings T<sub>.1</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
$V_{DSS}$	Drain to Source Voltage		80	V
$V_{GS}$	Gate to Source Voltage		±20	V
	Drain Current - Continuous ( $V_{GS}$ =10) (Note 1) $T_C$ = 25°C Pulsed Drain Current $T_C$ = 25°C		110	Α
ID			See Figure4	_ ^
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 2)		1167	mJ
D	Power Dissipation		333	W
$P_{D}$	Derate above 25°C		2.22	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance Junction to Case		0.45	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient (Note 3)		43	°C/W

# **Package Marking and Ordering Information**

Device N	larking	Device	Package	Reel Size	Tape Width	Quantity
FDB86	6360	FDB86360_F085	D2-PAK(TO-263)	330mm	24mm	800 units

- Current is limited by bondwire configuration.
   Starting T<sub>J</sub> = 25°C, L = 0.57mH, I<sub>AS</sub> = 64A, V<sub>DD</sub> = 80V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche
- 3: R<sub>0.1A</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

Units

Max

# **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted

**Parameter** 

Off Characteristics								
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, \	/ <sub>GS</sub> = 0V	80	-	-	V	
I <sub>DSS</sub>	Drain to Source Leakage Current	V <sub>DS</sub> =80V,	$T_{J} = 25^{\circ}C$	-	-	1	μΑ	
		$V_{GS} = 0V$	$T_J = 175^{\circ}C(Note 4)$	-	-	1	mA	
less	Gate to Source Leakage Current	$V_{CS} = \pm 20V$		_	_	±100	nA	

**Test Conditions** 

Min

Тур

# On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		2.0	3.0	4.5	V
r <sub>DS(on)</sub> Drain to Source On Resistance	Drain to Course On Desistance	I <sub>D</sub> = 80A,	$T_{J} = 25^{\circ}C$	-	1.5	1.8	$m\Omega$
	Diani to Source On Resistance	V <sub>GS</sub> = 10V	$T_J = 175^{\circ}C(Note 4)$	-	2.7	3.2	mΩ

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	2577.77		-	14600	-	pF
C <sub>oss</sub>	Output Capacitance		- V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, - f = 1MHz		4700	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 11VII 12			370	-	pF
$R_g$	Gate Resistance	f = 1MHz	f = 1MHz		3.2	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	V <sub>GS</sub> = 0 to 10V	V <sub>DD</sub> = 40V	-	207	253	nC
$Q_{g(th)}$	Threshold Gate Charge	V <sub>GS</sub> = 0 to 2V	I <sub>D</sub> = 80A	-	27	34	nC
$Q_{gs}$	Gate to Source Gate Charge			-	78	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge			-	47	-	nC

# **Switching Characteristics**

t <sub>on</sub>	Turn-On Time		-	-	388	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	75	-	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 40V, I <sub>D</sub> = 80A,	-	197	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$	-	86	-	ns
t <sub>f</sub>	Fall Time		-	70	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	226	ns

# **Drain-Source Diode Characteristics**

V <sub>SD</sub> Source to Drain Diode Voltage	Source to Drain Diode Voltage	I <sub>SD</sub> = 80A, V <sub>GS</sub> = 0V -	-	1.25	V	
	I <sub>SD</sub> = 40A, V <sub>GS</sub> = 0V	-	-	1.2	V	
T <sub>rr</sub>	Reverse Recovery Time	$I_F = 80A$ , $dI_{SD}/dt = 100A/\mu s$ ,	-	103	120	ns
Q <sub>rr</sub>	Reverse Recovery Charge	V <sub>DD</sub> =64V	-	212	260	nC

#### Notes:

4: The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.

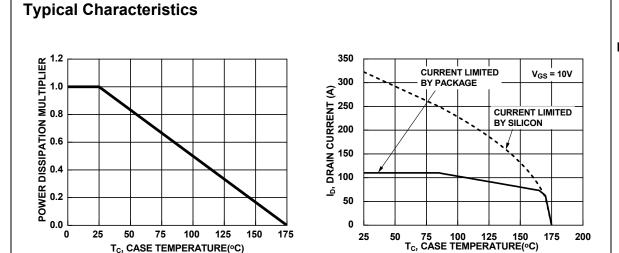
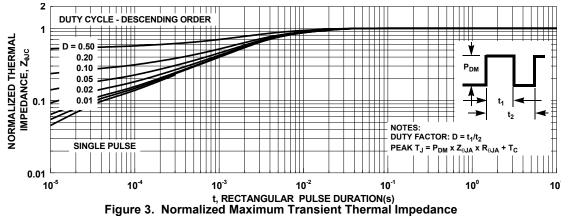


Figure 1. Normalized Power Dissipation vs Case **Temperature** 

Figure 2. Maximum Continuous Drain Current vs **Case Temperature** 



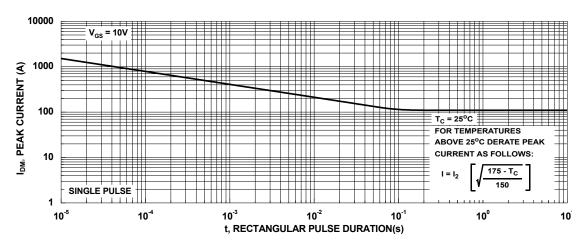


Figure 4. Peak Current Capability

# **Typical Characteristics**

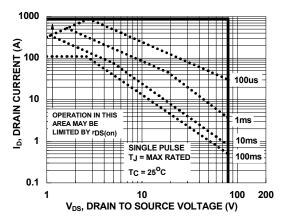
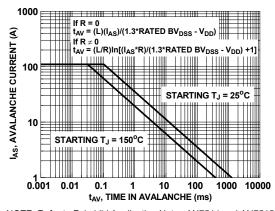


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

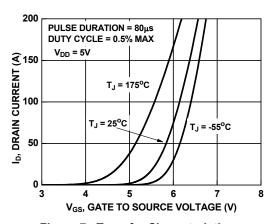


Figure 7. Transfer Characteristics

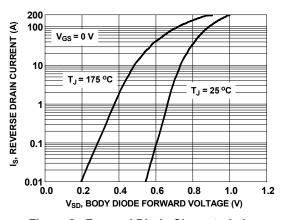


Figure 8. Forward Diode Characteristics

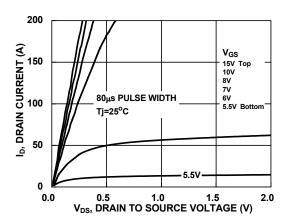


Figure 9. Saturation Characteristics

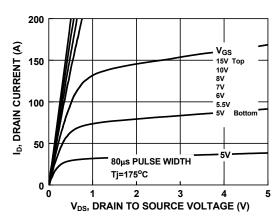


Figure 10. Saturation Characteristics

# **Typical Characteristics**

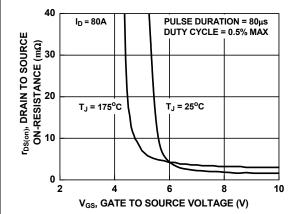


Figure 11. Rdson vs Gate Voltage

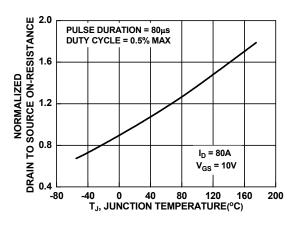


Figure 12. Normalized Rdson vs Junction Temperature

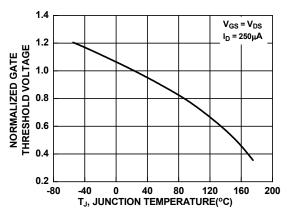


Figure 13. Normalized Gate Threshold Voltage vs
Temperature

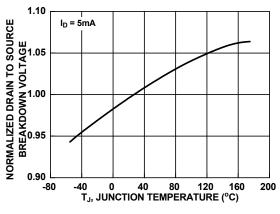


Figure 14. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

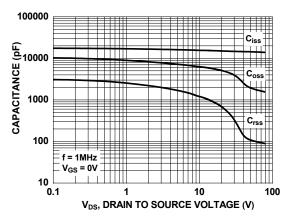


Figure 15. Capacitance vs Drain to Source Voltage

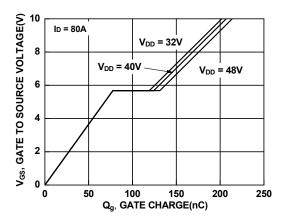


Figure 16. Gate Charge vs Gate to Source Voltage





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